		REQUEST FOR QU	JOTAT	ION						
H	PU:RF:003	BHARAT HEAVY ELECTRICALS LIMITEI Electronics Division PB No. 2606, Mysore Road Bangalore - 56002 INDIA	Q NUMBE (GOT0003							
(addre	ess for commu	nication) :		(for all correspondence) Purchase Executive : CHANDRA KANT KUN Phone : 08026989133 Fax : E-mail: ckgupta@bhel.in						
Sl No.		Description	Qty		Unit Delivery qty Delivery Date					
1	* HSN/SA Certificate	01PS51 MDL 69235PS51B SUB CONTRACT C : 8542 as per BHEL Norms cation ref no. TS/SA/RM/SPEC/PS/001	1,00	00	NO	1,000				
Total	Number of	Items - 1								
Not spli		red quantity will not be								

TWO PART BID - SUBMIT TECHNICAL AND PRICE BID IN SEPARATE SEALED COVERS

NOTES:

 This RFQ is governed by:
a) INSTRUCTIONS TO BIDDERS/SELLERS and GENERAL CONDITIONS OF CONTRACT FOR PURCHASE available at http://edn.bhel.com (RFQ-PO Terms & Conditions)
b) Any other specific Terms and Conditions mentioned.
2 Bidders / Representatives who would like to be present during opening of offers are required to furnish

2. Bidders / Representatives who would like to be present during opening of offers are required to furnish authorization letter for the same.

* The HSN/SAC no mentioned against the line items in the RFQ are indicative only.

For and On behalf of BHEL.

CHANDRA KANT KUMAR Sub-Assembly

1 OF 1

Date:

Τo,

M/s Bharat Heavy Electricals Ltd. Electronics Division, Mysore Road,' Bangalore – 560026

Sub: Model Clause / Certificate as per Annex-III (Tenders) of Restrictions Under Rule 144 (xi) of the General Financial Rules (GFRs) 2017, Dated 23.07.2020.

Ref: BHEL Tender / RFQ / NIT Number

For M/s

Authorized Signatory (with company seal & Name)

On Bidder Letter Head

Date:

Τo,

M/s Bharat Heavy Electricals Ltd. Electronics Division, Mysore Road,' Bangalore – 560026

Sub: Model Clause / Certificate as per clause 9 (a) of Revised Public Procurement (Preference to Make in India Order, 2017 of DPIIT dated 13.06.2020.

Ref: BHEL Tender / RFQ / NIT Number

The address is as below, where the local content / value addition is made:

[Factory Address]

For M/s

Authorized Signatory (with company seal & Name)

661833/2024/ED	N-SA/PPC	
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TECHNICAL SPECIFICATION FOR ASSEMBLY AND TESTING OF ELECTRONIC MODULES

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BHEL ELECTRONICS DIVISION Technical Specification for Assembly of Electronic Modules TS/SA/RM/SPEC/PS/001 Rev 00 P a g e | **2**

A. Pre-Qualification Criteria

- 1. The vendor shall have experience of Assembly of IPC Class 3 Products.
- 2. The Vendor shall have IPC Certified professionals for Assembly, Testing and Rework. Relevant Documents to be submitted along with Technical Bid.
- 3. The Turnover of the Vendor company to be more than 25 Crores in financial Year 2023-24, vendor to submit audited balance sheet of financial year 2023-24. Audited financial reports to be submitted along with Technical Bid.
- 4. The Vendor should be in the business of assembly of Electronic Modules for at least 1 Year. A declaration to the same effect is to be submitted along with Technical Bid.
- 5. The Vendor shall be based in and around 150 KMs of Bangalore.
- 6. An audit of the vendor facility to be conducted by BHEL, if required.
- BG of approx. Rs. 55,00,000 (Fifty-five lakhs only) to submitted for an assembly order of 1000 nos. of ED69235PS51B. A Declaration of agreement to Submit BG within 14 days from receipt of the work order, is to be submitted along with the technical bid.
- 8. The Vendor has to be an EMS vendor, having a manufacturing facility of their own with all required capabilities, further outsourcing of any activity is to be done with prior approval of BHEL.

B. Technical Specification:

The electronic modules are to be assembled as per the assembly documents provided. Requirements of assembly capability, inputs required, methodology to be followed and clearance of assembled modules are as given below.

C. Facilities required for Manufacturing:

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BHEL ELECTRONICS DIVISION
Technical Specification for Assembly of Electronic
Modules

The Vendor shall have following facilities / capabilities in the assembly shop:

- 1. Fully Automated SMT Assembly Line
- 2. To Handle PCBs of sizes upto 510 X 510 MM
- 3. Pick and Place machine to handle 0402 to 50X50 mm Size components.
- 4. To handle upto 150 Component types in a Single assembly.
- 5. To handle components in Reel / Tube and Tray from.
- 6. Process capability, Cpk of > 1.2
- 7. Placement accuracy of 30 Microns at 3 Sigma or better
- 8. Printer accuracy of +/- 20 Microns at six sigma or better
- 9. Automatic Printer with auto wiper and camera alignment
- 10. Reflow oven of minimum 8 + 2 Zones.
- 11. BGA Rework Station
- 12. 3D AOI.
- 13. ESD / MSD safe Practices may be strictly followed in all stages of assembly.
- 14. Other Facilities
- Cold Storage
- Dry Cabinets
- Component Storage facility
- Tracking of Solder paste and Components
- Component Counter
- Vacuum sealing machine.
- PCB Baking oven
- PCB Cleaning machine
- Wave Soldering / Selective Soldering / Robotic Soldering
- Automatic Lacquering Machine
- Component Preparation machine
- Temperature Cycling Chambers
- Test Equipment

D. Inputs to be provided by BHEL for Assembly

- 1. Reflow and wave profiles will be provided if required.
- 2. Placement programs via Gerber file / Excel file BOM
- 3. Stencil Gerber will be provided

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- 4. Components as per BOM
- 5. Engineering Documents required for assembly

E. Consumables

BHEL Approved vendor list with part number for consumables are as below for Solder Paste, Solder Stick, Flux, Solder wire, Silica Gel, IPA and packing box. The same is to be procured by the vendor and used.

SI.No.	Item	Supplier	Part No
1	Solder Paste	HYBRID METALS	AIM-NC254
		PVT. LTD.	a
		SUMITRON	KESTER-EP256
		EXPORTS PVT. LTD	
	· · · 8	COOKSON INDIA	COOKSON-OM5100
	5 C	LIMITED	
		BERGEN SYSTEMS	KOKI-SS48M 956-2
		PVT. LIMITED	
		MECTRONICS	HEREAUS-F352
		MARKETING	
		SERVICES	
2	Solder Stick	B T SOLDERS PVT	Sn63:Pb37
	ан сан сан сан сан сан сан сан сан сан с	LTD	
	2 a	HYBRID METALS	Sn63:Pb37
		PVT. LTD.	· •
		COOKSON INDIA	Sn63:Pb37
		LIMITED	n
		HIFLO SOLDERS	Sn63:Pb37
8		PVT. LTD.	
3	Flux	HYBRID METALS	PART NO.908 NO CLEAN
		PVT. LTD.	FLUX
· ·		COOKSON INDIA	ALPHA NO CLEAN FLUX RF-
		LIMITED	800
4	Solder Wire	B T SOLDERS PVT	SN62
		LTD	

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	2	HYBRID METALS	SN62
		PVT. LTD.	
		COOKSON INDIA	SN62
		LIMITED	
5	IPA	THERMO FISHER	IPAELGR
	2	SCIENTIFIC INDIA	
	s	PVT.	
	3	FINAR CHEMICALS	IPAELGR
	к К	LIMITED	
		SUPRAVENI	IPAELGR
	u N	CHEMICALS	
	u	PRIVATE LIMITED	
6	Packing Box	FICUS PAX PRIVATE	36923560099
		LIMITED	5
		HELIOS PACKAGING	36923560099
		SUPERPACKS	36923560099
		BUSINESS	× ·
	3	SOLUTIONS LLP	

F. Material Handling

of the company.

1. All Components required for manufacturing as per the BOM has to be collected at BHEL. 3% contingency components will be provided. List of Components is as below;

	r			1		I	2			74	1	
		-						Qty for	1			
	SI.					Qty	1	1000		*		
	No	Code Num	ber	Description	on	Mo	dule	Module	es	Unit		
	1	DV069234	9073	FRONT H	EAT SINK		1.03	1	030	NO		
	2	PW235PS5	51A1A	PCB 6923	5PS51A		1.03	1	030	NO		
				SCREW F	LAT HEAD PZ							
	3	DV069234	349103 M3X8 ZN		M3X8 ZN		3.09	309		NO		
				SCREW F	LAT HEAD PZ							
	4	DV069234	9111	M3X10 Z	N .		1.03	1	030	NO		
	5	DV069234	9120	NUT M3	ZN		4.12	4	120	NO		6
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			1		SA Engg		SA PPC		SA	Prod		SA Test
used direct	Electricals Limited. It must not be used directly or indirectly in anyway detrimental to the interest		Appro	oved by:	M. Sue	ent	-			madi S (SA –		PC & MRC)

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1	T.		î.		
	5	INSULATING WASHER 2		8	
6	DV0692350071	RM10	2.06	2060	NO
-	DV0C02250000	INSULATOR SLEEVE			
7	DV0692350080	D3X1	4.12	4120	NO
	DV0C00050000	INSULATOR CERAMIC			
8	DV0692350098	AIO TO-220	1.03	1030	NO
9	DV0602250110	INSULATOR KOOL-PAD	1.02	1020	NO
9	DV0692350110		1.03	1030	NO
10	DV0692350101	INSULATOR KOOL-PAD	1.03	1030	NO
11	DV0692348930	LIGHT-PIPE FOR LEDS	1.03	1030	NO
	010052540550	IC ANALG SMD VREF	1.05	1050	
		2.5V0.5%TL431 SOT-			
12	DV0692348883	23-3	3.09	3090	NO
	2)	IC ANALOG SMD TEMP			
13	DV0692348450	SENSOR LM75BIMX-3	1.03	1030	NO
		IC ANALOG SMD PWM			
1.4	DV0C02248402	CONTROLLER	1.02	1020	
		LM5026MT	1.03	1030	NO
15 DV0692359435		IC SMD ORING CONTROLLER LM5051	2.06	2060	NO
15	00032333433		2.00	2060	NU
16	IC ANALOG SMD 16 DV0692348468 LTC3851IGN#TRPBF		1.03	1030	NO
10	510052540400		1.05	1050	
17	IC ANALOG SMD 17 DV0692343091 COMPARATOR LM293		3.09	3090	NO
		OPTOCOUPLER SMD	5105		
18	DV0692348921	SFH6186-3T	2.06	2060	NO
		TRANSISTOR SMD PNP			
19	DV0692348484	BC807-25 SOT-23	1.03	1030	NO
	e.	TRANSISTOR SMD NPN			u.
20	DV0692348476	BC817-25 SOT-23	6.18	6180	NO
		MOSFET N-CHANNEL		a l	
21	DV0692349162	100V TO-220AB THT	1.03	1030	NO
		TRANSISTOR MOSFET	<i>6</i>		
22	DV0692348794	TO-220 IRL3705ZPBF	2.06	2060	NO
•		MOSFET N-CHANNEL			
23	DV0692349162	100V TO-220AB THT	1.03	1030	NO
	· · · · · · · · · · · · · · · · · · ·	MOSFET TO-220			
24	24 DV0692348808 IRF6218PBF		1.03	1030	NO

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1	1 ·	1	1		
	1	TRANSISTOR MOSFET			6
25	25 DV0692348794 TO-220 IRL3705ZPBF		1.03	1030	NO
		MOSFET N-CHANNEL			
26	DV0692349170	TO-220AB THT	1.03	1030	NO
		THERMISTOR NTC			
27	DV0692348700	B57235-S100-M51	1.03	1030	NO
28	DV0692348875	DIODE SMD BYG22D	3.09	3090	NO
	5	DIODE SMALL SIGN.	Я		
29	DV0692349189	MINIMELF LL4148 SMD	8.24	8240	NO
		DIODE SCHOTTKY			
30	DV0692348867	MBRS340 SMD	1.03	1030	NO
	* a	DIODE DUAL SCHOTTKY	5 8		
31	DV0692348760	RECTIFIER 150V THT	1.03	1030	NO
		DIODE DUAL SCHOTTKY			
32	DV0692348859	16CTQ100STRRPBF	1.02	1020	
52	DV0092348859	SMD	1.03	1030	NO
33	DV0692348824	ZENER DIODE 9.1V	2.00	2000	NO
- 33	DV0092348824	0.5W SMD BZV55-C9V1	2.06	2060	NO
34	DV0692348816	ZENER DIODE 3.3V	1.02	1000	
54	DV0092348810	0.5W SMD BZV55-C3V3	1.03	1030	NO
25	DV0002248840	ZENER DIODE 16V	1.02	4000	
	35 DV0692348840 0.5W SMD BZV55-C16 ZENER DIODE 12V ZENER DIODE 12V		1.03	1030	NO
36			1.02	4000	
30	DV0692348832	0.5W SMD BZV55-C12	1.03	1030	NO
27	DV0002252252	LED RED APTD3216EC	1.02	4000	
37	DV0692352252	SMD	1.03	1030	NO
20	DV0002252244	LED GREEN			
38	DV0692352244	APTD3216SGC SMD VARISTOR 68V	3.09	3090	ŇO
39	DV0692348697	VARISTOR 68V V68ZT2P	2.06	2060	ŇO
			2.00	2000	
40	DV0692348433	SWITCH TOGGLE SPDT RIGHT ANGLED	1.03	1030	NO
	210052540455	RESISTOR 8K25 1%	1.05	1020	
41	DV0692348581	0805 SMD	2.06	2060	NO
	2,0002040001	RESISTOR 681K 1%	2.00	2000	NO
. 42	DV0692348662	0805 SMD	1.03	1030	NO
		RESISTOR 511R 1%	1.05	1050	110
43	DV0692348565	0805 SMD	3.09	3090	NO
			5.05	3030	

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44	DV0692348514	RES CHIP SMD 1206 4R75 1% 0.25W 100PPM	1.03	1030	NO
45	DV0692348654	RESISTOR 332K 1% 0805 SMD	3.09	3090	NO
46	DV0692348590	RESISTOR 30K1 1% 0805 SMD	1.03	1030	NO
47	DV0692348573	RESISTOR 2K43 1% 0805 SMD	2.06	2060	NO
48	DV0692348557	RESISTOR 274R 1% 0805 SMD	2.06	2060	NO
49	DV0692348646	RESISTOR 274K 1% 0805 SMD	1.03	1030	NO
50	DV0692349197	FUSIBLE RES SMD 1206 22R 5% 0.25W 100PPM	1.03	1030	NO
51	DV0692348638	RESISTOR 221K 1% 0805 SMD	2.06	2060	NO
52	DV0692349219	RES MF SMD MINI MELF 200R 1% 0.25W 50PPM	2.06	2060	NO
53	DV0692348530	RES CHIP SMD 1206 182R 1% 0.25W 100PPM	1.03	1030	NO
54	DV0692359451	RES CHIP SMD 1206 8.2K 1% 0.25W 100PPM	2.06	2060	NO
55	DV0692348620	RESISTOR 154K 1% 0805 SMD	3.09	3090	NO
56	RESISTOR 133K 1% DV0692348611 0805 SMD		2.06	2060	NO
57	DV0692348522	RES CHIP SMD 1206 12R1 1% 0.25W 100PPM	2.06	2060	NO
58	DV0692348603	RESISTOR 120K 1% 0805 SMD	2.06	2000	NO
		RES CHIP SMD 1206 0.06R 1% 0.25W	8	1020	NO
59	DV0692356770	75PPM RESISTOR 0R008 1%	1.03	1030	NO
60	DV0692348948	2W 2512 SMD	1.03	1030	NO

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	· ·	а а 1			*				r		1		30
				RES SMT	332R .1W		×.,						
	61	DV069233	0681	100PPM	1% 0805		1.03	10)30	NO			
-				0.00	SMD MINI								
					OR 1% 0.25W			-					
1	62	DV069234	9227	50PPM			4.12	41	20	NO	-		
					P SMD 4.75K								
.	63	DV069230	5653	1% 0.1W	/ 100PPM 0805		6.18	61	80	NO			
1				RES CHIP	P SMD 27.4K					-			
	64	DV069230	6390	1% 0.1W	/ 100PPM 0805		2.06	20	060	NO			
	~			RES CHIP	P SMD 18.2K								
1	65	DV069230	0902		/ 100PPM		2.06	20	060	NO			
				RES CHIP	SMD 1206						: *		
1	66	DV069234	7623		0.25W 100PPM		1.03	10	030	NO			
ļ				RES CHIP	P SMD 1206								
-	67	DV069234	7542	in the second se	0.25W 100PPM		3.09	30	90	NO			
1					P SMD 1206				2				
1	68	DV069234	7615		0.25W 100PPM		1.03	10	030	NO			
ł					P SMD 1206 1K			10	<u> </u>				
	69	DV069234	7593		W 100PPM		3.09	30	90	NO			
		DVOOJE	1332								в		
	70	DV069234	7524	to account of the second second	P SMD 1206 0.25W 100PPM		1.03	10	030	NO			
ł		DV00525-1	100-		P SMD 0805		1.05			NO			
ļ			I	6K8 1% 0									
ļ	71	DV069234	3725	100PPM			1.03	10	30	NO			
ļ	[SMD 0805								
ļ			-1	3KO 1% 0	S S S S S S S S S S S S S S S S S S S								
ļ	72	DV069234	3768	100PPM			1.03	10	30	NO			
ļ					P SMD 0805								
ļ				2K2 1% 0				110	_				
	73	DV069234	3598	100PPM			11.33	113	30	NO	ł		
	1				P SMD 0805								
	74	DV069234	2530	22R 1% 0 100PPM			2.06	20	60	NO			
.	/4	DVUUJZJT	5555		P SMD 0805	23	2.00	20	60	NU_	1		
				22K 1% 0		*	r				l		
	75	DV069234	3652	100PPM			1.03	10	30	NO			
	•				SMD 0805								
	1. 1	l	/	20K 1% 0									
	76	DV069234	3695	100PPM			1.03	10	30	NO			
1				RES CHIP	SMD 0805 1R			12 (1) (1) (1) (1) (1) (1) (1) (1) (1) (1)					
	77	DV069234	4411	1% 0.125	5W 250PPM		2.06	20	60	NO		-	
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used directly	ly or indire	ectly in	Appro	oved by:	1. C.						udhir,		
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		RES CHIP SMD 0805 1M			
78	DV0692343415	1% 0.125W 100PPM	1.03	1030	NO
		RES CHIP SMD 0805			
79	DV0692343717	1K5 1% 0.125W 100PPM	1.03	1020	NO
75	00092343717		1.05	1030	NU
80	DV0692343580	RES CHIP SMD 0805 1K 1% 0.125W 100PPM	2.06	2060	NO
- 00	010092343380	RES CHIP SMD 0805	2.00	2000	NO
	и 2	10R 1% 0.125W			
81	DV0692343520	100PPM	3.09	3090	NO
		RES CHIP SMD 0805			
		10K 1% 0.125W			
82	DV0692343628	100PPM	9.27	9270	NO
		RES CHIP SMD 0805			
83	DV0692344365	100K 1% 0.125W 100PPM	2.06	2060	NO
05	000000000000000000000000000000000000000		2.00	2000	
84	DV0692343504	RES CHIP SMD 0805 0R00 0.125W	2.06	2060	NO
04	010032343304		2.00	2000	140
85	DV0692348735	CAP SMD 470pF 50V NP0 0805 5%	1.03	1030	NO
	510052510755	CAP SMD 2.2nF 50V	1.05	1050	
86	DV0692348743	X7R 0805 10%	1.03	1030	NO
		CAP SMD 10nF 50V X7R	1.05	1050	
87	DV0692348751	0805 10%	1.03	1030	NO
		CAP ELECTROLYTIC			
		2200uF 16V			
88	DV0692348719	EEUFM1C222	6.18	6180	NO
	. *	CAP ELECTROLYTIC			
00	D) (00000040707	1000uF 35V			
89	DV0692348727	EEUFM1V102	4.12	4120	NO
00	DV00000040147	CAP CER X7R 100NF	11.22	44220	<i>.</i>
90	DV0692346147	10% 50V 0805 SMD	11.33	11330	NO
01	DV0C02244242	CAP CER 1NF 5% 50V		FAFO	NG
91	DV0692341242	30PPM COG 0805 SMD	5.15	5150	NO
02	DV0603350030	CAP 100PF 5% 50V NP0	2.05	2000	NO
92	DV0692350020	0805 SMD	2.06	2060	NO
	DV0692350039	CAP 8.2NF 5% 250V	2.00	2000	NO
93	00092350039	1206 NP0 SMD	3.09	3090	NO
04	DV/0602249090	CAP 680pF 500V X7R	1.02	1020	NO
94	DV0692348980	1206 10% SMD	1.03	1030	NO

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		ant p		CAP 4.7	uF 50V X7R					-
	95	DV069234	9022	1812 10	% SMD	3.09	3090) NO		
ч		82		CAP 22n	F 50V X7R			22		
	96	DV069234	8956	0805 10	% SMD	2.06	2060	NO		
a				CAP 220	pF 500V NP0					
	97	DV069234	8972	1206 5%	SMD	2.06	2060) NO		
				CAP 2.2r	nF 500V X7R					
	98	DV069234	8964	1206 10	% SMD	4.12	4120) NO		
				CAP 1uF	50V Y5V 1210		5			
	99	DV069234	9014	20% SM	D	5.15	5150	NO		
				CAP 1NF	10% 500V X7R					
	100	DV069235	0047	1206 SN	ЛD	1.03	1030	NO		
, A				CAP 10u	F 16V Y5V					
	101	DV069234	9006	+80/-20	% SMD	3.09	3090	NO		
				CAP 10n	F 630V X7R					
	102	DV069234	9030	1206 10	% SMD	7.21	7210	NO		
				CAP 100	pF 500V NP0					
	103	DV069234	8999	1206 5%	SMD	4.12	4120	NO		
				CAP 100	nF 630V X7R					
	104	DV069234	9049	1812 10	% SMD	3.09	3090	NO		
				FUSE SM	1D 10A					
	105	DV069234	8441	0451010).MRL	1.03	1030	NO		
	107	DV069235	0055	INDUCTO	OR 4uH, 9A	1.03	1030	NO		
	12			TRANSFO						
	100	DUOCODD			CURRENT SENSE SMD		1020			
	108	DV069234	9057	P8207NI	COMMON	1.03	1030	NO		
					mH 6A WE-	5 S	8			
	109	DV069234	9065	CMB		1.03	1030	NO		
	110	DV069235		Transformer for IPSP		1.03	1030			
	111	DV069235		Inductor for IPSP		1.03	1030			
	3			CONNEC	TOR DUAL		1			
				ROW R A	NGLED 15-24-	2	×			
	112	DV069234	8425	9144		1.03	1030	NO		
				LIGHTPIF	PE 1 FOLD DISP					
	113	DV069235	0160	FOR SMI	D LED	1.03	1030	NO		ж 11
	e.				ERRITE 7uH 7A	-				
	114	DV069235		-10 +30%		1.03	1030			
	115	DV069234		CASING		1.03	1030			
	116	DV069234	T	HEAT SIN	NK - IPSP	1.03	1030	NO		AL
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117	DV0692350003	SCREW CSK ST2.9X9.5 SELF TAP ST DIN7982C	10.3	10300	NO
		SCREW M2.5X4 PHILIP			
118	DV0692351273	ST DIN7985A	5.15	5150	NO
119	DV0692356720	THERMAL PASTE P12	0.002	2	ML
120	DV0692356738	GLUE PASTE RTV	0.002	2	ML
121	CN9088281025	WASHER SPRING A 3.2	4.12	4120	NO
122	DV0692353011	GRAPHIC PANEL (IPSP)	1.03	1030	NO
		TYPE LABEL (M80)			
123	DV0692357548	69235PS51B - IPSP	1.03	1030	NO
125	DV0692353356	TYPE LABEL (LICENSEE)	1.03	1030	NO
		DIODE SWITCHING			
127	DV0692353089	TS4148RY 0805 SMD	1.03	1030	NO
		ZENER DIODE 16V			
128	DV0692348840	0.5W SMD BZV55-C16	1.03	1030	NO
		CAP CER 2.2MF 50V			
129	DV0692350069	X7R 1206 10% SMD	1.03	1030	NO

- 2. SMD Components will be given in standard packaging, where the component collected will be more than the required components, extra components after completion of the job to be returned with proper packaging (Vacuum sealing of MSL Components) and account at BHEL. Counting and Sealing of Components at vendor's place is to be witnessed and certified by a BHEL personnel.
- 3. Finished product has to be delivered at BHEL with due closure of gate pass.
- 4. Test jig, if provided by BHEL, to be returned after assembly is over and modules are accepted at BHEL.

G. Inspection at vendor place

- BHEL may depute Inspector at vendor works for witness of process at different stages.
- Modules after testing with all test certificate are to be offered for inspection at the vendor's place. BHEL personnel will visit vendors place for inspection and may witness sample testing of the modules. Modules to be dispatched to BHEL, only after clearance from BHEL Personnel.

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H. Testing

- Testing is to be done as per document reference DDC8330-D201832-3 (Production Test Specification,) ED 085 00 99 (Thermal Cycling) and DDC8330 HV-test instructions.
- Mounting bases and test jig required for Testing will be provided by BHEL, which is to be returned back to BHEL on completion of the order.
- > Suggested List of Test Instruments Required:

Type of Instrument	Make	Model No.
DMM	Agilent 6.5 DMM	34410A
Power Supply	Delta Electronika	30V 10A
Electronic Load	HP	6060A
Rheostat		9ohms 12A
DMM	Handheld	4750D
Test Jig	Testing Interface	

I. Suggested Assembly process of PS51B

- > Collection of Materials from BHEL, EDN, Bangalore
- > Bottom Side SMD Assembly with Glue and Inspection
- > Top Side SMD Assembly with Paste and Inspection
- > TH components mounting
- > Wave soldering of TH and Bot side SMD Components
- > Inspection
- > Thermal Cycling
- > Testing as per the test procedure including HV Test
- Labelling at different Stages (No. of Stickers: 4)
- Application of Silicone adhesive at required locations
- Box Assembly of Module
- Delivery of Modules and remaining components at BHEL, EDN, Bangalore.
- > The assembly of module should comply with IPC class 3 requirements.

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J. Records

- 1. Vendor to maintain details of consumables batch number, expiry date, profiles used during assembly.
- 2. Records of AOI to be shared in soft media.
- 3. Functional Test report of each module to be provided.
- 4. Thermal Cycle report to be provided.

K. Packaging of Finished Product

The individual finished product has to be packed in ESD safe covers and then it has to be packed in ESD safe boxes to ensure safety of modules. Procurement of Packing materials is in vendor's scope.

L. Handling Troubleshooting / Rework

- Modules not getting pass on the functional test at BHEL, troubleshooting to be carried out by the vendor's personnel at BHEL.
- Any defect arising out of improper soldering, wrong assembly, defective components has to be attended at BHEL works by certified operators of Vendor.

M. Sample Lot / Bulk Production

- A sample lot of 10 nos. of modules to be assembled, tested and delivered to BHEL for functional test at BHEL.
- Bulk production of remaining modules are to be taken up only after clearance of the sample lot by BHEL.

N. Acceptance criteria

- 1. Visual Inspection: Boards will be inspected for assembly as per BOM on receipt at BHEL, if required.
- 2. Boards will be checked for any physical damage
- 3. Boards will be tested as per the test procedures

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- 4. The module will be deemed accepted, if BHEL observes that the failure is attributable to the material provided by BHEL and rework is not possible.
- 5. If the failure is attributable to workmanship / process / handling of the vendor and rework is not possible, the material cost of such modules will be deducted from the running bill or bank guarantee. Material Cost of each module is Rs. 5002.
- 6. Functional Testing of modules will be repeated at BHEL.
- 7. Final acceptance clearance will be given only after passing of all the test parameters as per the Test Instruction.

Annexure A :

All relevant documents required for the execution are given in Annexure A. The information contained in Annexure A are COPY RIGHT AND CONFIDENTIAL. The information in the document is the property of Bharat Heavy Electricals Limited. It must not be used directly or indirectly in anyway detrimental to the interest of the company.

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Annexure A

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Co-ordinarte Data :

NAME	POS X	POS Y	ORIENT.	ТҮРЕ	LAYER
FID1	0	0	0	FID	ТОР
FID2	25.001	106.002	0	FID	ТОР
FID3	0	0	0	FID	вот
FID4	25.001	106.002	0	FID	вот
C01	39.299	107.401	90	SMD	ТОР
C02	39.299	104.201	90	SMD	ТОР
C03	38.199	96.151	0	SMD	ТОР
C04	38.199	99.901	0	SMD	ТОР
C05	26.699	104.401	90	SMD	ТОР
C06	9.101	79.701	90	SMD	ТОР
C07	36.399	110.701	90	SMD	ТОР
C08	14.649	78.501	0	SMD	BOT
C09	2.941	49.801	0	THT	ТОР
C10	33.899	100.901	90	SMD	ТОР
C11	3.899	33.901	90	SMD	ТОР
C12	6.999	85.801	90	SMD	BOT
C13	26.199	75.301	0	SMD	BOT
C14	9.101	105.001	0	SMD	BOT
C15	21.099	10.601	90	SMD	BOT
C16	4.099	13.701	0	SMD	BOT
C17	43.399	19.901	90	SMD	BOT
C18	34.599	17.761	90	THT	ТОР
C19	3.939	3.801	0	THT	ТОР
C20	26.301	98.601	90	SMD	BOT
C21	19.799	4.801	0	SMD	ТОР
C22	15.299	13.301	90	SMD	ТОР
C23	21.999	42.501	90	SMD	BOT
C24	25.299	10.301	90	SMD	ТОР
C25	11.101	69.751	0	SMD	BOT
C26	17.101	66.501	90	SMD	BOT
C27	6.241	94.901	0	THT	ТОР
C28	15.741	103.601	0	THT	ТОР
C29	42.699	61.701	90	SMD	ТОР
C30	25.101	78.501	0	SMD	BOT
C31	19.351	72.751	0	SMD	BOT
C32	26.501	52.801	90	SMD	ВОТ
C33	16.901	29.101	90	SMD	BOT
C34	0.701	80.201	90	SMD	ТОР
C35	4.199	26.101	0	SMD	ТОР
C36	14.701	44.801	90	SMD	ТОР
C37	23.901	31.001	90	SMD	BOT
C38	3.541	107.501	0	THT	ТОР
C39	13.149	106.751	0	SMD	BOT
C40	25.401	98.401	0	SMD	ТОР
C41	14.999	8.501	90	SMD	BOT
C42	12.199	5.001	0	SMD	ТОР
C43	12.199	7.401	0	SMD	ТОР

C44	12.199	9.701	0	SMD	ТОР
C45	3.939	16.601	0	THT	ТОР
C46	39.899	19.901	90	SMD	BOT
C47	22.099	20.061	90	тнт	ТОР
C48	34.799	30.561	90	THT	ТОР
C49	12.499	110.701	90	SMD	ТОР
C50	36.899	6.401	90	SMD	вот
C51	25.401	102.101	0	SMD	ТОР
C52	27.899	111.251	90	SMD	ТОР
C53	15.099	110.701	90	SMD	ТОР
C54	17.599	110.701	90	SMD	ТОР
C55	25.399	107.751	90	SMD	ТОР
C56	2.199	80.001	90	SMD	BOT
C57	18.501	25.801	90	SMD	ТОР
C58	9.899	110.701	90	SMD	ТОР
C59	14.601	33.401	90	SMD	ТОР
C60	24.699	78.401	90	SMD	вот
C61	26.401	66.801	90	SMD	вот
C62	13.401	28.301	90	SMD	вот
C63	33.799	5.101	90	SMD	вот
C64	20.801	105.101	90	SMD	вот
C65	46.099	87.201	90	SMD	вот
C66	17.701	64.101	0	SMD	ТОР
C67	13.499	29.561	90	THT	ТОР
C68	26.501	58.101	90	SMD	BOT
C69	30.999	5.101	90	SMD	BOT
C70	28.199	5.101	90	SMD	BOT
C71	26.901	30.301	90	SMD	BOT
C100	2.799	98.101	90	SMD	BOT
C102	42.499	80.001	90	SMD	BOT
C105	39.149	41.251	0	SMD	ТОР
F01	11.101	60.501	0	SMD	ТОР
L01	23.999	46.001	0	THT	ТОР
L02	35.604	3.871	0	SMD	ТОР
L03	19.551	71.451	0	THT	ТОР
L10	13.101	85.628	90	THT	ТОР
N01	33.699	105.601	0	SMD	ТОР
N02	31.899	74.001	0	SMD	ТОР
N03	3.346	102.508	0	SMD	BOT
N04	18.301	110.201	0	SMD	BOT
N05	31.899	68.501	0	SMD	ТОР
N07	1.707	33.896	90	SMD	ТОР
N08	30.799	78.101	0	SMD	BOT
N09	26.835	42.493	0	SMD	BOT
N10	8.699	41.001	0	SMD	BOT
N11	16.835	42.493	0	SMD	BOT
N14	18.164	8.923	90	SMD	ТОР
N23	2.807	26.996	90	SMD	ТОР
N24	27.66	41.201	0	SMD	BOT
Q01	44.039	95.541	0	THT	ТОР

R001	42 200	74.801	90	CNAD	DOT
R001	42.399		90 90	SMD	BOT BOT
R002	41.799 34.649	104.201 88.001	0	SMD	
R003				SMD	TOP
	37.999	96.501	0	SMD	BOT
R005	43.899	88.751	0	SMD	TOP
R006	41.399	111.701	90	SMD	TOP
R007	15.001	106.601	90	SMD	BOT
R008	1.299	102.001	90	SMD	BOT
R009	5.199	98.101	90	SMD	BOT
R010	3.601	112.101	0	SMD	BOT
R011	7.599	98.101	90	SMD	BOT
R012	0.301	97.501	0	SMD	BOT
R013	4.101	97.501	0	SMD	BOT
R014	12.501	107.701	90	SMD	BOT
R015	5.899	111.001	90	SMD	BOT
R016	3.601	109.801	0	SMD	BOT
R017	26.501	89.341	90	THT	ТОР
R018	4.999	80.001	90	SMD	BOT
R019	1.999	80.201	90	SMD	ТОР
R020	34.299	77.901	90	SMD	BOT
R021	40.099	26.201	0	SMD	BOT
R022	46.599	16.301	90	SMD	ТОР
R023	44.299	5.201	0	SMD	ТОР
R024	2.999	84.501	0	SMD	BOT
R025	9.799	86.801	90	SMD	BOT
R026	31.599	100.901	90	SMD	ТОР
R027	12.599	86.801	90	SMD	BOT
R028	25.899	81.501	0	SMD	BOT
R029	19.599	78.401	90	SMD	BOT
R030	22.099	78.401	90	SMD	BOT
R031	27.299	78.401	90	SMD	BOT
R032	25.599	72.201	0	SMD	BOT
R033	31.399	42.901	90	SMD	BOT
R034	26.099	36.501	90	SMD	BOT
R035	20.999	49.501	90	SMD	BOT
R036	20.999	53.501	90	SMD	BOT
R037	21.299	36.501	90	SMD	BOT
R038	23.499	49.501	90	SMD	BOT
R039	25.999	49.501	90	SMD	BOT
R040	23.699	36.501	90	SMD	BOT
R041	31.999	48.501	90	SMD	BOT
R042	44.099	34.921	90	SMD	BOT
R043	40.799	51.601	90	SMD	ТОР
R044	12.099	42.501	90	SMD	BOT
R045	16.299	36.501	90	SMD	BOT
R046	17.699	30.601	90	SMD	BOT
R047	11.499	36.501	90	SMD	BOT
R048	20.299	30.601	90	SMD	BOT
R049	14.999	49.501	90	SMD	BOT
R050	13.899	36.501	90	SMD	BOT

D051	12 200	40 501	00	CNAD	DOT
R051	12.299	49.501	90	SMD	BOT
R052	44.099	29.841	90	SMD	BOT
R053	34.499	43.001	90	SMD	BOT
R054	40.799	48.101	90	SMD	ТОР
R055	34.499	37.501	90	SMD	BOT
R056	39.149	38.751	0	SMD	ТОР
R057	32.099	37.501	90	SMD	BOT
R058	44.099	40.001	90	SMD	BOT
R059	36.099	109.101	0	SMD	BOT
R060	32.199	111.501	0	SMD	ВОТ
R061	27.899	107.751	90	SMD	ТОР
R062	25.399	111.251	90	SMD	ТОР
R063	27.899	107.251	90	SMD	BOT
R064	32.199	109.101	0	SMD	BOT
R065	30.599	73.401	90	SMD	BOT
R066	18.001	99.301	90	SMD	вот
R067	24.399	13.101	90	SMD	BOT
R068	12.199	12.101	0	SMD	ТОР
R069	12.199	14.401	0	SMD	ТОР
R070	12.399	8.501	90	SMD	вот
R071	44.899	72.401	90	SMD	вот
R072	9.899	8.501	90	SMD	вот
R073	12.299	17.001	90	SMD	вот
R074	36.099	111.501	0	SMD	вот
R075	8.701	72.801	0	SMD	ТОР
R076	11.851	99.001	90	SMD	вот
R077	6.401	79.901	90	SMD	ТОР
R078	8.701	75.501	0	SMD	ТОР
R079	16.499	12.901	90	SMD	вот
R080	11.699	12.901	90	SMD	BOT
R081	14.999	17.001	90	SMD	BOT
R084	8.049	106.751	0	SMD	BOT
R083		91.101	90	SMD	ТОР
R085	45.099	65.801	0	SMD	ТОР
R086	45.099	68.501	0	SMD	ТОР
R087	9.399	78.501	0	SMD	BOT
R088	23.901	98.601	90	SMD	BOT
R089	14.099	12.901	90	SMD	BOT
R090	14.799	1.999	0	SMD	ТОР
R091	41.599	71.601	0	SMD	BOT
R092	9.099	49.501	90	SMD	BOT
R093	5.999	46.501	90	SMD	BOT
R094	37.799	104.401	0	SMD	BOT
R100	14.699	1.301	0	SMD	ТОР
R102	37.999	96.601	0	SMD	BOT
R102	17.901	94.601	90	SMD	BOT
R105	36.899	10.501	90	SMD	BOT
R105	13.036	54.441	90	THT	ТОР
R108	24.641	83.116	0	ТНТ	ТОР
R109	10.149	81.301	0	SMD	BOT

R110	16.199	4.801	0	SMD	ТОР
R131	4.099	4.801 29.601	0	SMD	ТОР
R150	4.099 26.501	34.801	90	SMD	BOT
R150	25.801	47.501	90	SMD	BOT
R151	25.801	47.501	90 90	SMD	BOT
T01	34.399	47.301 81.751	0	SMD	ТОР
T02	14.999	89.101	0		ТОР
V001		89.101 78.461	90	ТНТ	
V001 V002	45.299 38.899	91.801	90 90	THT SMD	TOP BOT
V002 V003	37.899	92.501	0	SMD	ТОР
V003	21.899	107.541	90	THT	ТОР
V004 V005	21.899	107.341	0	SMD	BOT
V005	43.899	95.701	90	SMD	BOT
			0		ТОР
V007 V008	43.699 5.874	105.001 65.626	0 45	SMD SMD	ТОР
V008 V009	5.874 24.899	107.251	45 0	SMD	BOT
V009 V010	24.899 23.999	107.251 99.701	0 45	SMD	ТОР
V011 V012	46.799 25.699	59.461 5.401	90	THT SMD	TOP TOP
			0		
V013	1.191 15.599	40.399	0	THT	ТОР
V014		84.601	90	SMD	BOT
V015	38.199	35.001	90	SMD	BOT
V016	44.099	34.921	90 90	SMD	TOP
V017	38.199	30.201		SMD	BOT
V018 V019	44.099	29.841	90 90	SMD	TOP
	28.999	49.501		SMD	BOT
V020	17.999 41.599	49.501	90 90	SMD SMD	BOT
V021 V022	41.399	9.801 46.001	90 90	SMD	BOT TOP
V022 V023	44.424 38.199	48.001 39.801	90 90	SMD	BOT
V023	44.099	40.001	90	SMD	ТОР
V024 V025	44.099	40.001 50.001	90	SMD	ТОР
V025		21.461	90	THT	ТОР
V028 V027	46.799	8.461	90 90	ТНТ	ТОР
V027	43.399	85.251	0	SMD	ТОР
V028	43.399 10.276	42.901	90	SMD	ТОР
V029	10.276	42.901 35.101	90	SMD	ТОР
V030 V031	10.526	54.801	90 90	SMD	BOT
V031	11.299	54.801 54.801	90 90	SMD	BOT
V032	5.701	83.476	0	SMD	ТОР
V034 V035	8.851	83.478 99.501	90	SMD	BOT
V046	8.901	25.741	90	THT	ТОР
V048 V051	20.901	30.301	90 90	SMD	BOT
V101	20.901	99.101	90 90	SMD	BOT
V101 V102	18.401	89.501	90 90	SMD	BOT
V102 V103	21.501	90.741	90	THT	ТОР
X01	20.035	47.428	90 90	THT	ТОР
NUT	20.033	71.420	30	1171	

No. of Solder Points

SMD Solder Points BOT	609
SIMD Solder Follits DOT	005

SMD Solder Points TOP	419
TH Solder Points	186









DDC8330-D201832-3 Production Test Specification

Created by:

JDa

Issue	Date	Description of Change	Ref CR	Approved
8330-0.4	15/01/2010	1 st Draft	-	
8330-1	27/05/2010			JSe
8330-3	24/5/2011	Parameter change / minor update		JDa

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1 GENERAL

Purpose of this document is to describe production test requirements for series DDC8330.

2 **REFERENCES TO OTHER DOCUMENTS**

Document	Reference	Notes
Test Plan for production	DDC8330-D201832-3 Test spec.doc	
Parts list	n/a	
Product functional description	n/a	
Schematics drawing	83310G.sch	
PCB layout	83320G.pcb	
Drill plot for test pads	n/a	

2.1 DESCRIPTION OF TERMS

Signal or Symbol	Description
DUT	Device under test
Flying probe	Special tester where are few moving nail probes
FCT	Functional test
ICT	In-circuit test
AOI	Automatic optical inspection
Screening	Same as burn in or ageing
HV test	High voltage isolation test
Interposer	Tester interface with connectors
Fixture	Tester interface with bed of nails
Test station	Including computer and test rack (in FCT)

3 GENERAL REQUIREMENTS

3.1 PRODUCTION TEST REQUIREMENTS FOR MODULE

Test phase	Needed for proto series	Needed for 0- series	Needed for final product	Testing time target	Notes
ICT	No	No	No		
Flying probe	No	No	No		
Optical test	No	No	No		
X-ray	No	No	No		
Visual test	Yes	Yes	Yes		
Screening	No	No	No		
HV test	No	No	No		
FCT	Yes	Yes	Yes		

3.2 PRODUCTION TEST REQUIREMENTS FOR ASSEMBLED PRODUCT

Test phase	Needed for proto series	Needed for 0- series	Needed for final product	Testing time target	Notes
Visual test	Yes	Yes	Yes		
Functional test	Yes	Yes	Yes		
Screening	No	No	No		
HV test	No	Yes	Yes		

4 MANUFACTURING PROCESS AND TESTING PHASES

4.1 Module test

1. Reference to "DDC8330 led test .doc".

- 2. Set 24VDC to input leads.
- 3. Set power switch on, green led near switch should be on and two leds on right side in a three led group are also green.
- 4. Power switch off, green led near switch should stay on, three led group should fade off.

NOTE

Use proper tools and safety covers.

4.2 HV test

- 1. Reference to "DDC8330 HV-test.doc".
- 2. Test voltage 500VDC (Insulation resistance) 3. Test should be done with appropriate test leads.
- 4. Insulation will be tested between primary and secondary, chassis is connected to secondary.
- 5. Insulation resistance should be over 999Mohms or infinite(∞), regarding to test instrument.

CAUTION

High voltage.

NOTE

Use proper tools and safety covers.

4.3 Final test (FCT)

Minimum requirements for final test station:

- DC power supply 30VDC 20A 600W Electronic load 2Ch. 300W/ch.
- DMM
- One signal relay control
- One AD measure channel.

Pin	Description
X1-1	0V
X1-2	PE
X1-3	I2C bus (scl)
X1-4	I2C bus (sda)
X1-5	DGND / AGND
X1-6	DGND / AGND
X1-7	+5V out
X1-8	+28V in
X1-9	+28V Field
X1-10	Fault output (open collector, ref DGND)
X1-11	+24V out
X1-12	DGND / AGND
X1-13	DGND / AGND
X1-14	DGND / AGND

4.3.1 Final test sequence descriptions

Sequ	ence ID	1	Report						
Name)	Start up voltage	PASS/F	AIL					
Sub	Interface	Signal name	Sub	Action		Value		QTY	NOTE!
ID			report		MIN	МАХ	NOM		
1	X1-11	Load +24V-line	Value	Write			1	А	CC-mode
2	X1-7	Load +5.3V-line	Value	Write			1	А	CC-mode
3	X1-8	Input voltage	Value	Write			18.5	VDC	
4	X1-9	Field-signal	Value	Write			18.5	VDC	
5		Start up time	Value	Read		2500		ms	
6	X1-11	Output +24V	Value	Read		5		VDC	
7	X1-8	Input voltage	Value	Write			21.5	VDC	1
8	X1-9	Field-signal	Value	Write			21.5	VDC	1
9		Start up time	Value	Read		2500		ms	
10	X1-11	Output +24V	Value	Read	5			VDC	

Sequence ID 2 Report												
Name	Name Shut down voltage			PASS/FAIL								
Sub Interface		Signal name	Sub	Action		Value		QTY	NOTE!			
ID		report	MIN	MAX	NOM							
1	X1-8	Input voltage	Value	Write			24	VDC				
2	X1-9	Field-signal	Value	Write			24	VDC				
3	X1-11	Load +24V-line	Value	Write			1	A	CC-mode			
4	X1-7	Load +5.3V-line	Value	Write			1	A	CC-mode			
5	X1-8	Input voltage	Value	Write			21.3	VDC				

6	X1-9	Field-signal	Value	Write			21.3	VDC	
7		Shut down time	Value	Read		4500		ms	
8	X1-11	Output voltage +24V	Value	Read	5			VDC	
9	X1-8	Input voltage	Value	Write			18	VDC	
10	X1-9	Field-signal	Value	Write			18	VDC	
11		Shut down time	Value	Read		4500		ms	
12	X1-11	Output voltage +24V	Value	Read		5		VDC	

Seque	nce ID	3	Report						
Name	-	Output voltage measure	PASS/F	AIL					
Sub ID	Interface	Signal name	Sub report	Action		Value		QTY	NOTE!
			-	ļ	MIN	МАХ	NOM	1	
1	X1-11	Load +24V-line	Value	Write			0	A	CC-mode
2	X1-7	Load +5.3V-line	Value	Write			0	A	CC-mode
3	X1-8	Input voltage	Value	Write			24	VDC	
4	X1-9	Field-signal	Value	Write			24	VDC	
5		Delay	Value	Read			2500	ms	
6	X1-11	Output voltage +24V	Value	Read	23.5	24.5	24	VDC	
7	X1-7	Output voltage +5.3V	Value	Read	5.15	5.4	5.3	VDC	
8	X1-8	Input voltage	Value	Write			28	VDC	
9	X1-9	Field-signal	Value	Write			28	VDC	
10		Delay	Value	Read			2500	ms	
11	X1-11	Output voltage +24V	Value	Read	23.5	24.5	24	VDC	
12	X1-7	Output voltage +5.3V	Value	Read	5.15	5.4	5.3	VDC	
13	X1-11	Load +24V-line	Value	Write			1	А	CC-mode
14	X1-7	Load +5.3V-line	Value	Write			4	А	CC-mode
15	X1-8	Input voltage	Value	Write			24	VDC	
16	X1-9	Field-signal	Value	Write			24	VDC	
17		Delay	Value	Read			2500	ms	
18	X1-11	Output voltage +24V	Value	Read	23.5	24.5	24	VDC	
19	X1-7	Output voltage +5.3V	Value	Read	5.15	5.4	5.3	VDC	
20	X1-8	Input voltage	Value	Write			28	VDC	
21	X1-9	Field-signal	Value	Write			28	VDC	
22		Delay	Value	Read			2500	ms	
23	X1-11	Output voltage +24V	Value	Read	23.5	24.5	24	VDC	
24	X1-7	Output voltage +5.3V	Value	Read	5.15	5.4	5.3	VDC	
25	X1-11	Load +24V-line	Value	Write			2	A	CC-mode
26	X1-7	Load +5.3V-line	Value	Write			8	A	CC-mode
27	X1-8	Input voltage	Value	Write			24	VDC	
28	X1-9	Field-signal	Value	Write			24	VDC	
29		Delay	Value	Read			2500	ms	
30	X1-11	Output voltage +24V	Value	Read	23.5	24.5	24	VDC	
31	X1-7	Output voltage +5.3V	Value	Read	5.15	5.4	5.3	VDC	
32	X1-8	Input voltage	Value	Write			28	VDC	
33	X1-9	Field-signal	Value	Write			28	VDC	
34		Delay	Value	Read			2500	ms	
35	X1-11	Output voltage +24V	Value	Read	23.5	24.5	24	VDC	
36	X1-7	Output voltage +5.3V	Value	Read	5.15	5.4	5.3	VDC	

Seque	ence ID	4	Report						
Name)	Ripple voltage	PASS/F	AIL					
Sub	Interface	Signal name	Sub .	Action		Value			NOTE!
ID			report		MIN	MAX	NOM		
1	X1-11	Load +24V-line	Value	Write			1	A	CC-mode
2	X1-7	Load +5,3V-line	Value	Write		1	4	A	CC-mode
3	X1-8	Input voltage	Value	Write			24	VDC	
4	X1-9	Field-signal	Value	Write			24	VDC	
5	X1-11	Ripple voltage +24V	Value	Read		10		mVAC	
6	X1-7	Ripple voltage +5.3V	Value	Read		20		mVAC	
7	X1-11	Load +24V-line	Value	Write			2	A	CC-mode
8	X1-7	Load +5,3V-line	Value	Write			8	A	CC-mode
9	X1-8	Input voltage	Value	Write			24	VDC	
10	X1-9	Field-signal	Value	Write			24	VDC	1
11	X1-11	Ripple voltage +24V	Value	Read		10		mVAC	
12	X1-7	Ripple voltage +5.3V	Value	Read		20		mVAC	

Seque	ence ID	5	Report						
Name	•	Efficiency	PASS/F	AIL					
Sub	Interface	Signal name		Action		Value		QTY	NOTE!
ID			report		MIN	MAX	NOM		
1	X1-11	Load +24V-line	Value	Write			1	A	CC-mode
2	X1-7	Load +5.3V-line	Value	Write			4	A	CC-mode
3	X1-8	Input voltage	Value	Write			24	VDC	
4	X1-9	Field-signal	Value	Write			24	VDC	
5		Efficiency	Value	Read	85			%	
6	X1-11	Load +24V-line	Value	Write			2	A	CC-mode
7	X1-7	Load +5.3V-line	Value	Write			8	A	CC-mode
8	X1-8	Input voltage	Value	Write			24	VDC	
9	X1-9	Field-signal	Value	Write			24	VDC	
10		Efficiency	Value	Read	85			%	

Seque	ence ID	6	Report							
Name		Short circuit current	PASS/FAIL							
Sub	Interface	Signal name	Sub	Action		Value		QTY	NOTE!	
ID			report		MIN	MAX	NOM			
1	X1-8	Input voltage	Value	Write			24	VDC		
2	X1-9	Field-signal	Value	Write			24	VDC		
3	X1-11	Load +24V-line	Value	Write			Short	A	CC-mode	
4	X1-7	Load +5.3V-line	Value	Write			Short	A	CC-mode	
5		Delay	Value	Write			1500	ms		
6	X1-11	Output +24V	Value	Read	4	11.5		ADC		
7	X1-7	Output +5.3V	Value	Read	4.8	10		ADC		

Sequence ID		7	Report						
Name		Current limit (CV-mode)	PASS/FAIL						
Sub	Interface	Signal name	Sub	Action Valu		Value	/alue Q		NOTE!
ID			report		MIN	MAX	NOM		
1	X1-8	Input voltage	Value	Write			24	VDC	

2	X1-9	Field-signal	Value	Write			24	VDC	
3	X1-11	Load +24V-line	Value	Write			23	VDC	CV-mode
4	X1-7	Load +5.3V-line	Value	Write			5	VDC	CV-mode
5	X1-11	Output +24V	Value	Read	2	4.8		ADC	
6	X1-7	Output +5.3V	Value	Read	8	10		ADC	

Sequence ID Name		8	Report						
		Signal test	PASS/FAIL						
Sub ID	Interface	Signal name	Sub	Action		Value	Value		NOTE!
			report		MIN	МАХ	NOM		
1	X1-8	Input voltage	Value	Write			24	VDC	
2		Delay	Value	Read			2500	ms	
3	X1-10	Fault-signal	Value	Read	0	1	0.1	VDC	"0" when flt active
2	X1-11	Output +24V	Value	Read		5		VDC	
3	X1-9	Field-signal	Value	Write			24	VDC	
4		Delay	Value	Read			2500	ms	
5	X1-10	Fault-signal	Value	Read	4	5.5	5.3	VDC	"0" when flt active
6	X1-11	Output +24V	Value	Read	23	25		VDC	

4.4 Burn-In (Screening)

Not used/needed for this product.

DDC8330 High Voltage test (Insulation resistance).

Instruments needed:

- 1. Insulation resistance meter with 500VDC measure
- 2. DDC8330 insulation resistance test leads

Specifications:

- 1. Test voltage 500VDC
- 2. Typical insulation resistance >999M Ω or infinity ∞
- 3. Minimum insulation resistance $50M\Omega$



Picture 1: DDC8330 Insulation resistance test

Ver: 1.2 Page: 2 Date: 30.5.2024



Picture 2 DDC8330 Insulation test rig

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3HEL		PLANT STANDARD	ED 	085 00 99	
4 - 13		ELECTRONICS DIVISION	REV	NO 02	
44 - 13			PAG	E 1 OF 3	
	El	NVIRONMENTAL TESTING PROC TEMPERATURE CYCLING			
1.0	SCOI	PE:			
		To determine the abi equipment to withstand such as may occur during	rapid change:	s of temperati	ure in aim
	2.0	REFERENCE STANDARD: Guidance has been taken Change of Temperature,			
	3.0	GENERAL DESCRIPTION: The test object is expo in the air by alternate the low temperature and The low temperature s Deg C.The test object of such exposure.	exposure, in the other fo hall be -25 1	n two Chambers or the high te Deg C and the	s, one for emperature high +7(
	4.0	TEST CHAMBER: The test chamber shall i temperature to within ñ for the test.The tempe monitored by a thermon working space.	3 Deg [°] C of tl rature within	he temperature n the Chamber	e specified r shall be
	5.0 5.1	TESTING PROCEDURE: Carry out the followin its relevant test instr (a) Visual (b) Mechanical		the test objec	ct as per
	5.2	Expose the test object temperature as per the			changes in
			FIGURE-1		
		(a) Use two Chambers to	conduct this	s test.	
	REVIS	SIONS:	APPROVED: N.SRIDHARA	AN.	
			PREPARED: AV,MRV.	ISSUED: STDS.GROUP	DATE: . 28-08-92

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ייידנור		PLANT STANDARD	ED 085 00 99
BHEL		ELECTRONICS DIVISION	REV NO 02
A4 - 1	14		PAGE 2 OF 3
	(b) Ma	intain the temperature of the Ch	hamber at -25 Deg C and
]		the other at +70 Deg C.	
			ect first into the Chamber whose Deg C and keep it for 30 minutes
			ect from the cold Chamber and nber at 70 Deg C and keep it there
		(e) Step c&d constitute one cycles.	e cycle. Repeat the test for five
		(f) The test object shall during exposure to low	l not be electrically energised and high temperatures.
		-	sfer of the test object from one nall not exceed three minutes.
	5		s of exposure examine the test eformation, decolouration, etc.,
	5		e test object as identification apid temperature cycling test.
	5	.5 Repeat the test given in c per relevant Test Instructi	clause 5.1 and conduct tests as ions.
	5	below: a) Number of samples : 1 b) Test Agency : F c) Criteria for PASS/FAIL: have passed the test if it	ted as per the guidelines given 100% PCB Testing The object shall be deemed to the meets the requirements of this airable, can be repaired if any Defective components shall be ts that have also been subjected
	6		enerate and maintain the details as per clauses 5.1, 5.3, 5.4 and
	7	.0 TEST REPORT: Shall be made by the PCB Test	sting Group.

=== 0 ===



ende		Special commercial conditions of Contract (SCC)		
	er department: SA MM, EDN, BHEL, BANG.	ALORE Bidder Name	RFQ/NIT/Enquiry no.	CKGOT00038
nde	er floated through NIC e-Procurement syste	em Website - https://eprocurebhel.co.in/nicgep/app . Vendor to submit offer only though NIC e-Procurement system.		
C to	b be read along with Instructions to Bidder	s (document reference: BHELEDN:ITB-SHOP: Rev 03), General Conditions of Contract (document reference: BHELEDN:GCC-St	HOP: Rev 01)	
r.	DESCRIPTION	Details	Bidder's Response	Remarks if any
10 1	Price Basis	The quoted prices will be firm till supply completion of the tendered quantity.		-
_	Terms of Delivery	DDL, BHEL EDN, Bangalore (Free delivery to EDN/BHEL Bangalore including packing & forwarding charges)		
_	Delivery Period	For 10 nos. samples:		
		8 weeks from the date of issue of Purchase order by BHEL.		
		For Balance quantity:		
		15 weeks from the date of issue of Purchase order by BHEL.		
		Date of require a functorial at DUFLEDN will be treated as delivery for purpose of penalty calculation. DUFL will increase		
		Date of receipt of material at BHEL EDN will be treated as delivery for purpose of penalty calculation. BHEL will inspect within 1 week from the date of receipt of Inspection call from supplier. Clearance for sample lot will be given by BHEL		
		within 2 weeks from the date of receipt of inspection can non supplier. Clearance for sample for win be given by brick within 2 weeks from the date of receipt of sample at BHEL-EDN.		
-	Payment Term	100% direct payment with 45 days credit from the date of receipt of material at BHEL Stores		
5	Evalution of L1 vendor	All the items of tender shall be considered as single package for evaluation and ordering		
6	GeM Seller id	All the items of tender shall be considered as single package for evaluation and ordering Mention the Government E-marketplace (GeM) Seller id. The same is mandatory for placing Purchase order by BHEL.		
5		mention the dovernment termarketprace (dem) series to the same is manuatory for pracing Functions of def by BREL.		
7	Penalty for delay in delivery	Penalty of 0.5% per week at the basic price of the good for undelivered quantity of supply portion, subject to a maximum		
		of 10%. Date of receipt of material at BHEL EDN Stores will be treated as date of delivery for purpose of penalty		
_		calculation		
	Loading towards Penalty for delay in	For any deviation in penalty term, the offer will be liable for loading as per ITB.		
	delivery Other terms & conditions	For detailed Terms and Conditions, kindly refer to the following:		
1		Instructions to Bidders (document reference: BHELEDN:ITB-SHOP: Rev 03)		
		and General Conditions of Contract (document reference: BHELEDN:GCC-SHOP: Rev 01) attached with this tender		
10	Validity	Quotation should remain valid for a period of 90 days from the due date.		
	Reverse Auction	Reverse Auction is not applicable for tender		
	Declaration for GFR 2017 Rule 144(Xi)	Decleration to be uploaded (Format attached)		
	Declaration for Make in India Declaration	Decleration to be uploaded (Format attached) The bidder declares that they will not enter into any illegal or undisclosed agreement of understanding, whether formal		
14	Decidiation	or informal with other bidder(s). This applies in particular to prices, specifications, subsidiary contracts, submission or non	_	
		submission of bids or any other actions to restrict competitiveness or to introduce cartelization in the bidding process.		
		In case, the Bidder is found having indulged in above activities, suitable action shall be taken by BHEL as per extent		
		policies/guidelines.		
_	Warranty	18 months from the date of supply.		
10	Bank Guarantee	a. L1 Vendor to provide Bank Guarantee for INR 55 lacs within 14 days from the date of placement of Purchase order. b. Materials will be issued by BHEL only after submission of Bank Guarantee by the Supplier and Supplier to collect the		
		materials within 7 days of intimation by BHEL		
17	No Deviation	We hereby confirm that all the terms & conditions of tender are accepted without any deviation . Any additional		
		commercial term or deviation in commercial term mentioned anywhere else shall be ignored and not be considered for evaluation		
18	Documents for bill processing	Complete set of despatch documents (original + 1 photocopy set) as per Purchase Order shall be submitted to Purchase		
		Officer directly on below address for bill processing -		
		If documents are Digitally Signed by Authorized Signatory, submission of Hard copy of document is not required. However	r	
		digitally signed soft copy of complete set of documents to be sent to below email IDs,		
		Depending upon the PO, despatch documents may include one or more documents from the following:		
		1. Invoice for payment (original)		
		2. Invoice for payment (extra copy)		
		2. Invoice for payment (extra copy) 3. Warranty certificate		
		 Invoice for payment (extra copy) Warranty certificate Copy of UDYAM certificate for considering MSE, if applicable 		
		2. Invoice for payment (extra copy) 3. Warranty certificate		
		 Invoice for payment (extra copy) Warranty certificate Copy of UDYAM certificate for considering MSE, if applicable 		

(1) Any tender condition does not prohibit any bidder to submit their offer along with clause wise deviation from the specification/commercial terms of tender. Changes, if any, in technical specification / Scope/commercial term etc shall be informed to participating bidders only.

(2) Any additional commercial term or deviation in commercial term, if sought by vendor, should be clearly brought out in this commercial bid document. Any additional commercial term or deviation in commercial term mentioned anywhere else shall be ignored and not be considered for evaluation

(3) Any technical or commercial clarification for this tender can be raised within one week of floating tender. No clarification will be entertained by BHEL after given cutoff date.

(4) The evaluation currency for this tender shall be INR.

(5) For the purpose of availment of GST amount as Input Tax Credit (ITC), time limits are mentioned and as of now it is September of the subsequent Financial Year. If complete set of invoice and other supporting billign document required as per PO is not submitted to concerned Purchase Officer at leat 45 days prior to this cut-off date, BHEL will not be able to avail Input Tax Credit and hence corresponding GST amount will not be paid to the vendor / contractor.

(6) FOR THIS PROCUREMENT, PUBLIC PROCUREMENT (PREFERENCE TO MAKE IN INDIA), Order 2017 dated 15.06.2017 & 28.05.2018 and subsequent Orders issued by the respective Nodal Ministry shall be applicable even if issued after issue of this NIT but before finalization of contract/PO against this NIT. In the event of any Nodal Ministry prescribing higher or lower percentage of purchase preference and/or local content in respect of this procurement, same shall be applicable

(7) PURCHASE PREFERENCE FOR MSE VENDORS:

MSE vendors quoting within a price band of L1 + 15% shall be allowed to supply up to 25% of the requirement against this tender provided i. The MSE vendor matches the L1 price. ii. L1 price is from a non MSE vendor. iii. L1 price will be offered to the vendor nearest to L1 in terms of price ranking (L2 - nearest to L1). In case of non-acceptance by the MSE vendor (L2), next ranking MSE vendor will be offered who is within the L1 + 15% band (if L3 is also within 15% band). iv. 3% of the 25% will be earmarked for women owned MSEs. v. 25% of the 25% (i.e., 6.25% of the total enquired quantity) will be earmarked for SC/ST owned MSE firms provided conditions as mentioned in (1) and (2) or have not participated in the tender, the 6.25% of earmarked quantity for SC/ST owned MSE firms will be distributed among the other eligible MSE vendors who have participated in the tender, vii. Tendered quantity will not be split. In case after the bid opening it is seen that no MSE has become L1, then BHEL would counter offer the L1 prices to MSE bidders within the +15% band of L1 and will be awarded for complete supply of total tendered value to MSE considering the spirit of the Policy for enhancing Govt. Procurement from MSEs.

(8) Conflict of interest

"A bidder shall not have conflict of interest with other bidders. Such conflict of interest can lead to anti-competitive practices to the detriment of Procuring Entity's interests. The bidder found to have a conflict of interest shall be disqualified. A bidder may be considered to have a conflict of interest with one or more parties in this bidding process, if:

a) they have controlling partner (s) in common; or

b) they receive or have received any direct or indirect subsidy/ financial stake from any of them; or

c) they have the same legal representative/agent for purposes of this bid; or

d) they have relationship with each other, directly or through common third parties, that puts them in a position to have access to information about or influence on the bid of another Bidder, · or

e) Bidder participates in more than one bid in this bidding process. Participation by a Bidder in more than one Bid will result in the disqualification of all bids in which the parties are involved. However, this does not limit the inclusion of the components/ sub-assembly/ Assemblies from. one bidding manufacturer in more than one bid; or

f) In cases of agents quoting in offshore procurements, on behalf of their principal manufacturers, one agent cannot represent two manufacturers or quote on their behalf in a particular tender enquiry. One manufacturer can also authorise only one agent/dealer. There can be only one bid from the following:

The principal manufacturer directly or through one Indian agent on his behalf; and

2. Indian/foreign agent on behalf of only one principal, or

g) A Bidder or any of its affiliates participated as a consultant in the preparation of the design or

technical specifications of the contract that is the subject of the Bid, · or

h) In case of a holding company having more than one independently manufacturing units, or more than one unit having common business ownership/management, only one unit should quote. Similar restrictions would apply to closely related sister companies. Bidders must proactively declare such sister/ common business/ management units in same/ similar line of business.